

P/N XX-666000-00 SOIC-to-SOWIC Adapter

FEATURES

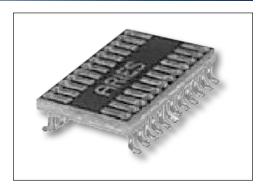
Allows the use of a narrow package IC in place of a wide one.

GENERAL SPECIFICATIONS

- LEADS: mechanically fastened and soldered to adapter's PCB subtrate
- PCB: FR-4, 0.062 [1.56] or 0.094 [2.39] thick manufactured to IPC 600E Class 2 standards
- MALE PIN: Brass 360 1/2-hard per UNS C36000, ASTM B16/B16M
- MALE PIN PLATING: 200μ [5.08μ] Sn/Pb 93/7 per ASTM B579-73 over 100μ [2.54μ] Ni per SAE AMS-QQ-N-290
- OPERATING TEMPERATURE: 221°F [105°C]

MOUNTING CONSIDERATIONS

- Standard SMT mounting to PCB
- SMT Package can be IR reflowed, vapor phased, or simply hand soldered



CUSTOMIZATION: In addition to the standard products shown on this page, Aries specializes in custom design and production. Special materials, platings, sizes, and configurations can be furnished, depending on the quantity. **NOTE:** Aries reserves the right to change product general specifications without notice.

ALL DIMENSIONS: INCHES [MILLIMETERS]

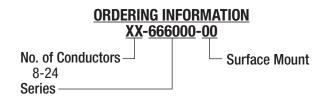
ALL TOLERANCES: ±0.005 [0.13] UNLESS OTHERWISE SPECIFIED

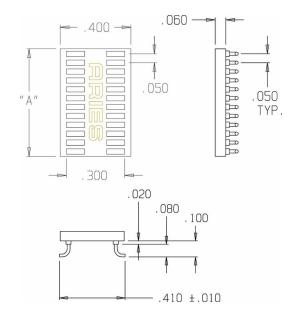
PADS ARE 0.076 [1.93] x 0.024 [0.61]

"A" DIMENSION = 1/2 x TOTAL PIN COUNT x 0.050 [1.27] + 0.030 [0.76]

ALL CAC'S ARE MANUFACTURED AND INSPECTED TO IPC- 610B CLASS 2 GUIDELINES

CONSULT FACTORY FOR OTHER SIZES AND CONFIGURATIONS







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